Lam Research Keynote at SEMICON® West 2025 to Reveal a Future-Ready Approach to Innovation in the AI Era

Additional Lam speakers will present on a range of technology topics

Fremont, Calif., Oct. 2, 2025 – Sesha Varadarajan, senior vice president of the Global Products Group at Lam Research, will deliver a keynote address at SEMICON® West 2025, exploring how the semiconductor industry must transform across talent and technology to meet the demands of the AI era. The annual trade show will run October 7-9 at Phoenix Convention Center in Arizona, convening global semiconductor industry leaders for discussion, education and collaboration.

Other leaders from Lam Research will also speak at the conference on pertinent industry topics such as innovation in deposition and etch technologies, advanced packaging, virtualization, advanced patterning, and more. A detailed schedule follows.

Tuesday, October 7

- **AI in Every Layer: Future-Ready Strategy for Technology and Talent (CEO Summit Keynote)**
  Sesha Varadarajan, senior vice president, Global Products Group, Lam Research
  9:10-9:35 a.m.; West Building, 300 Level, Ballroom 301A

- **Using Virtual Silicon & Machine Learning to Improve Yield in Advanced Semi Manufacturing**
  Joseph Ervin, managing director, Semiverse® Solutions, Lam Research
  10:55-11:15 a.m.; Smart Manufacturing Pavilion Theater, North Building, Lower Level, Expo Floor

- **Strategic Silicon: Geopolitics Shaping the Future of Semiconductors (Panel)**
  Rich Ashooh, corporate vice president, Global Trade and Government Affairs, Lam Research
  1:30-2:20 p.m.; West Building, 300 Level, Ballroom 301A

- **Climate FRESK (Keynote)**
  Wojtek Osowiecki, product marketing engineer, Global Products Group, Lam Research
  4:05-4:10 p.m.; Sustainability Pavilion Theater, West Building, Lower Level, Expo Floor

- **CESI in Action (Panel)**
  Wojtek Osowiecki, product marketing engineer, Global Products Group, Lam Research
  4:10-4:45 p.m.; Sustainability Pavilion Theater, West Building, Lower Level, Expo Floor

Wednesday, October 8

- **AI Disruption in Semiconductors: Technologies, Supply Chains, Market Forces**
  David Fried, corporate vice president, Semiverse Solutions®, Lam Research
  11 a.m.-2 p.m.; Regency Ballroom, Hyatt Regency Phoenix

- **Material Matters: Why Dielectrics are the Pivot Point in Packaging**
  Ming Li, vice president for strategic projects, Dielectric Group, Lam Research
  3:20-3:45 p.m.; West Building, 100 Level, Room 105 BC

- **Building and Scaling AI: From Design to Productization (Panel)**
  Audrey Charles, senior vice president, Corporate Strategy and Advanced Packaging, Lam Research (moderator)
  Ming Li, vice president for strategic projects, Dielectric Group, Lam Research (panelist)

4:10-5:10 p.m.; West Building, 100 Level, Room 105 BC

Thursday, October 9

- **Overcoming the Big Challenges in Patterning Small Features**
  Rich Wise, vice president, Patterning Technology Group, Lam Research
  11:35-11:55 a.m.; TechTALKS, North Building, 300 Level, Expo Hall B

- **Scope 3 Emissions, Energy Use and Industry Collaboration**
  Sara Turner, climate program manager, ESG, Lam Research
  2:30-3 p.m.; Sustainability Pavilion Theater, West Building, Lower Level, Expo Floor

Lam Research is a Platinum sponsor of this event. Visit theSEMICON West website for more information about speakers and sessions.

Contact: publicrelations@lamresearch.com

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https://newsroom.lamresearch.com/2025-10-02-Lam-Research-Keynote-at-SEMICON-R-West-2025-to-Reveal-a-Future-Ready-Approach-to-Innovation-in-the-AI-Era